# HT93LC66

## CMOS 4K 3-Wire Serial EEPROM

#### **Features**

Operating voltage V<sub>CC</sub>

Read: 2.0V~5.5VWrite: 2.4V~5.5V

Low power consumption
Operating: 5mA max.
Standby: 10μA max.

• User selectable internal organization

- 4K(HT93LC66): 512×8 or 256×16

3-wire Serial Interface Write cycle time: 5ms max.

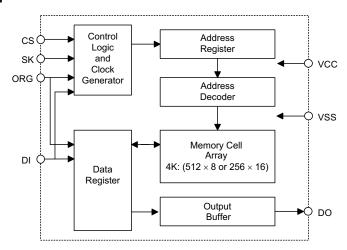
- · Automatic erase-before-write operation
- Word/chip erase and write operation
- · Write operation with built-in timer
- · Software controlled write protection
- 10-year data retention after 100K rewrite cycles
- 10<sup>6</sup> rewrite cycles per word
- Commercial temperature range (0°C to +70°C)
- 8-pin DIP/SOP package

## **General Description**

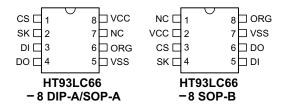
The HT93LC66 is a 4K-bit low voltage nonvolatile, serial electrically erasable programmable read only memory device using the CMOS floating gate process. Its 4096 bits of memory are organized into 256 words of 16 bits each when the ORG pin is connected to VCC or organized into 512 words of 8 bits each when it is tied to VSS. The device

is optimized for use in many industrial and commercial applications where low power and low voltage operation are essential. By popular microcontroller, the versatile serial interface including chip select (CS), serial clock (SK), data input (DI) and data output (DO) can be easily controlled.

## **Block Diagram**



## **Pin Assignment**





## **Pin Description**

Pin Name	I/O	Description
CS	I	Chip select input
SK	I	Serial clock input
DI	I	Serial data input
DO	0	Serial data output
VSS	_	Negative power supply, ground
ORG	I	Internal Organization When ORG is connected to VDD or ORG is floated, the ( $\times$ 16) memory organization is selected. When ORG is tied to VSS, the ( $\times$ 8) memory organization is selected. There is an internal pull-up resistor on the ORG pin. (HT93LC66-A)
NC	_	No connection
VCC	_	Positive power supply

## **Absolute Maximum Ratings**

Operation Temperature (Commercial)	0°C to 70°C
Applied V <sub>CC</sub> Voltage with Respect to VSS	0.3V to 6.0V
Applied Voltage on any Pin with Respect to VSS	V <sub>SS</sub> -0.3V to V <sub>CC</sub> +0.3V
Supply READ Voltage	2V to 5.5V

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

### **D.C. Characteristics**

Cumah al	Parameter		Test Conditions	Min.	T	Mari	Unit
Symbol	Parameter	Vcc	Conditions	iviin.	Тур.	Max.	
V	On anotin a Maltana		Read	2.0	_	5.5	V
V <sub>CC</sub>	Operating Voltage	_	Write	2.4	_	5.5	V
I <sub>CC1</sub>	Operating Current (TTL)	5V	DO unload, SK=1MHz	_	_	5	mA
1	On another Comment (CMOC)	5V	DO unload, SK=1MHz	_	_	5	mA
I <sub>CC2</sub>	Operating Current (CMOS)	2~5.5V	DO unload, SK=250kHz —		_	5	mA
I <sub>STB</sub>	Standby Current (CMOS)	5V	CS=SK=DI=0V	_	_	10	μΑ
ILI	Input Leakage Current 5V V <sub>IN</sub> =V <sub>SS</sub> ~V <sub>CC</sub>		V <sub>IN</sub> =V <sub>SS</sub> ~V <sub>CC</sub>	0	_	1	μА
I <sub>LO</sub>	Output Leakage Current	5V	V <sub>OUT</sub> =V <sub>SS</sub> ~V <sub>CC</sub> , CS=0V	0	_	1	μΑ
.,	Innert Law Valtage	5V	_	0	_	0.8	V
V <sub>IL</sub>	Input Low Voltage	2~5.5V	_	0	_	0.1V <sub>CC</sub>	V
.,	land tide Valtage	5V	_	2	_	V <sub>CC</sub>	V
V <sub>IH</sub>	Input High Voltage	2~5.5V	_	0.9V <sub>CC</sub>	_	V <sub>CC</sub>	V
\/	Outrot Law Valtage	5V	I <sub>OL</sub> =2.1mA	_	_	0.4	V
V <sub>OL</sub>	Output Low Voltage	2~5.5V	I <sub>OL</sub> =10μA	_	_	0.2	V
V <sub>OH</sub>	Outrot High Valtage	5V	I <sub>OH</sub> =–400μA	2.4	_	_	V
	Output High Voltage	2~5.5V	I <sub>OH</sub> =-10μA	V <sub>CC</sub> -0.2	_	_	V
C <sub>IN</sub>	Input Capacitance	_	V <sub>IN</sub> =0V, f=250kHz	_	_	5	pF
C <sub>OUT</sub>	Output Capacitance V <sub>OUT</sub> =0V, f=		V <sub>OUT</sub> =0V, f=250kHz	_	_	5	pF

Rev. 1.20 2 October 29, 2001



## A.C. Characteristics

Symbol	Parameter	V <sub>CC</sub> =5V±10%		V <sub>CC</sub> =3V±10%		V <sub>CC</sub> =2V*		Unit
	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Uilit
f <sub>SK</sub>	Clock Frequency	0	2000	0	500	0	250	kHz
tskH	SK High Time	250	_	1000		2000		ns
t <sub>SKL</sub>	SK Low Time	250		1000	_	2000	_	ns
t <sub>CSS</sub>	CS Setup Time	50	_	200	_	200	_	ns
t <sub>CSH</sub>	CS Hold Time	0	_	0	_	0	_	ns
t <sub>CDS</sub>	CS Deselect Time	250	_	250	_	1000	_	ns
t <sub>DIS</sub>	DI Setup Time	100	_	200	_	400	_	ns
t <sub>DIH</sub>	DI Hold Time	100	_	200	_	400	_	ns
t <sub>PD1</sub>	DO Delay to "1"	_	250	_	1000	_	2000	ns
t <sub>PD0</sub>	DO Delay to "0"	_	250	_	1000	_	2000	ns
t <sub>SV</sub>	Status Valid Time	_	250	_	250	_	_	ns
t <sub>HV</sub>	DO Disable Time	100	_	400	_	400	_	ns
t <sub>PR</sub>	Write Cycle Time	_	5		5	_	_	ms

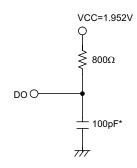
<sup>\*</sup> For Read Operating Only

### A.C. test conditions

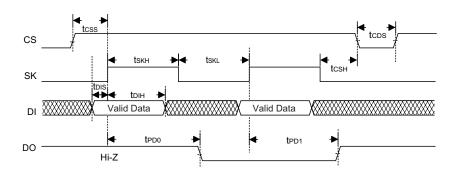
Input rise and fall time: 5ns (1V to 2V)

Input and output timing reference levels: 1.5V

Output load circuit: See Figure right



\*Including scope and jig





### **Functional Description**

The HT93LC66 is accessed via a three-wire serial communication interface. The device is arranged into 256 words by 16 bits or 512 words by 8 bits depending whether the ORG pin is connected to VCC or VSS. The HT93LC66 contains seven instructions: READ, ERASE, WRITE, EWEN, EWDS, ERAL and WRAL. When the user selectable internal organization is arranged into 256×16 (512×8), these instructions are all made up of 11(12) bits data: 1 start bit, 2 op code bits and 8(9) address bits

By using the control signal CS, SK and data input signal DI, these instructions can be given to the HT93LC66. These serial instruction data presented at the DI input will be written into the device at the rising edge of SK. During the READ cycle, DO pin acts as the data output and during the WRITE or ERASE cycle, DO pin indicates the BUSY/READY status. When the DO pin is active for read data or as a BUSY/READY indicator the CS pin must be high; otherwise DO pin will be in a high-impedance state. For successful instructions, CS must be low once after the instruction is sent. After power on, the device is by default in the EWDS state. And, an EWEN instruction must be performed before any ERASE or WRITE instruction can be executed. The following are the functional descriptions and timing diagrams of all seven instructions.

#### **READ**

The READ instruction will stream out data at a specified address on the DO pin. The data on DO pin changes during the low-to-high edge of SK signal. The 8 bits or 16 bits data stream is preceded by a logical "0" dummy bit. Irrespective of the condition of the EWEN or EWDS instruction, the READ command is always valid and independent of these two instructions. After the data word has been read the internal address will be automatically incremented by 1 allowing the next consecutive data word to be read out without entering further address data. The address will wrap around with CS High until CS returns to LOW.

#### **EWEN/EWDS**

The EWEN/EWDS instruction will enable or disable the programming capabilities. At both the power on and power off state the device automatically entered the disable mode. Before a WRITE, ERASE, WRAL or ERAL instruction is given, the programming enable instruction EWEN must be issued, otherwise the ERASE/WRITE instruction is invalid. After the EWEN instruction is issued, the programming enable condition remains until power is turned off or a EWDS instruction is given. No data can be written into the device in the programming disabled state. By so doing, the internal memory data can be protected.

#### **ERASE**

The ERASE instruction erases data at the specified addresses in the programming enable mode. After the ERASE op-code and the specified address have been issued, the data erase is activated by the falling edge of CS. Since the internal auto-timing generator provides all timing signals for the internal erase, so the SK clock is not required. During the internal erase, we can verify the busy/ready status if CS is high. The DO pin will remain low but when the operation is over, the DO pin will return to high and further instructions can be executed.

#### **WRITE**

The WRITE instruction writes data into the device at the specified addresses in the programming enable mode. After the WRITE op-code and the specified address and data have been issued, the data writing is activated by the falling edge of CS. Since the internal auto-timing generator provides all timing signal for the internal writing, so the SK clock is not required. The auto-timing write cycle includes an automatic erase-before-write capability. So, it is not necessary to erase data before the WRITE instruction. During the internal writing, we can verify the busy/ready status if CS is high. The DO pin will remain low but when the operation is over, the DO pin will return to high and further instructions can be executed.

### **ERAL**

The ERAL instruction erases the entire 256×16 or 512×8 memory cells to logical "1" state in the programming enable mode. After the erase-all instruction set has been issued, the data erase feature is activated by the falling edge of CS. Since the internal auto-timing generator provides all timing signal for the erase-all operation, so the SK clock is not required. During the internal erase-all operation, we can verify the busy/ready status if CS is high. The DO pin will remain low but when the operation is over, the DO pin will return to high and further instruction can be executed.

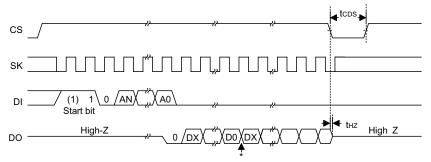
#### WRAL

The WRAL instruction writes data into the entire 256×16 or 512×8 memory cells in the programming enable mode. After the write-all instruction set has been issued, the data writing is activated by the falling edge of CS. Since the internal auto-timing generator provides all timing signals for the write-all operation, so the SK clock is not required. During the internal write-all operation, we can verify the busy/ready status if CS is high. The DO pin will remain low but when the operation is over the DO pin will return to high and further instruction can be executed.



## **Timing Diagrams**

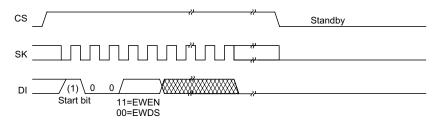
### **READ**



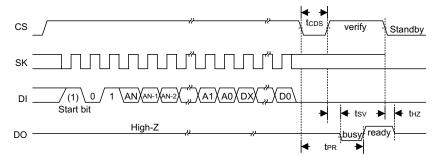
\* Address pointer automatically cycles to the next word

Mode	(X16)	(X8)		
AN	A7	A8		
DX	D15	D7		

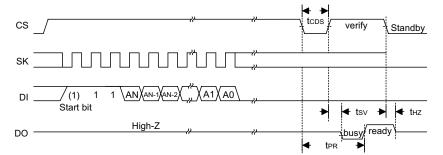
### **EWEN/EWDS**



### **WRITE**

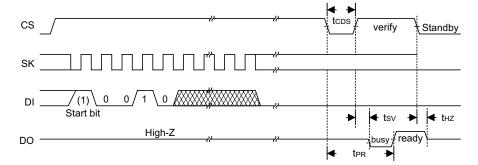


### **ERASE**

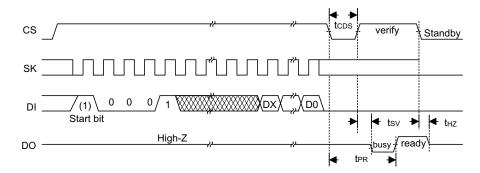




## **ERAL**



## WRAL



# **Instruction Set Summary**

## HT93LC66

Instruction	Comments	Start bit	Op Code	Address ORG=0 ORG=1 X8 X16	Data ORG=0 ORG=1 X8 X16
READ	Read data	1	10	A8~A0 A7~A0	D7~D0 D15~D0
ERASE	Erase data	1	11	A8~A0 A7~A0	_
WRITE	Write data	1	01	A8~A0 A7~A0	D7~D0 D15~D0
EWEN	Erase/Write Enable	1	00	11XXXXXXX 11XXXXXX	_
EWDS	Erase/Write Disable	1	00	00XXXXXXX 00XXXXXX	_
ERAL	Erase All	1	00	10XXXXXXX 10XXXXXX	_
WRAL	Write All	1	00	01XXXXXXX 01XXXXXX	D7~D0 D15~D0

Note: "X" stands for "don't care"



#### Holtek Semiconductor Inc. (Headquarters)

No.3, Creation Rd. II, Science Park, Hsinchu, Taiwan

Tel: 886-3-563-1999 Fax: 886-3-563-1189 http://www.holtek.com.tw

## Holtek Semiconductor Inc. (Sales Office)

4F-2, No. 3-2, YuanQu St., Nankang Software Park, Taipei 115, Taiwan Tel: 886-2-2655-7070

Fax: 886-2-2655-7373

Fax: 886-2-2655-7383 (International sales hotline)

## Holtek Semiconductor (Shanghai) Inc.

7th Floor, Building 2, No.889, Yi Shan Rd., Shanghai, China

Tel: 021-6485-5560 Fax: 021-6485-0313 http://www.holtek.com.cn

### Holtek Semiconductor (Hong Kong) Ltd.

Block A, 3/F, Tin On Industrial Building, 7777-779 Cheung Sha Wan Rd., Kowloon, Hong Kong Tel: 852-2-745-8288

Fax: 852-2-742-8657

### Holmate Semiconductor, Inc.

46712 Fremont Blvd., Fremont, CA 94538

Tel: 510-252-9880 Fax: 510-252-9885 http://www.holmate.com

### Copyright © 2001 by HOLTEK SEMICONDUCTOR INC.

The information appearing in this Data Sheet is believed to be accurate at the time of publication. However, Holtek assumes no responsibility arising from the use of the specifications described. The applications mentioned herein are used solely for the purpose of illustration and Holtek makes no warranty or representation that such applications will be suitable without further modification, nor recommends the use of its products for application that may present a risk to human life due to malfunction or otherwise. Holtek's products are not authorized for use as critical components in life support devices or systems. Holtek reserves the right to alter its products without prior notification. For the most up-to-date information, please visit our web site at http://www.holtek.com.tw.

7 Rev. 1.20 October 29, 2001